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B.Tech IV Year II Semester (R13) Regular & Supplementary Examinations April 2018

## **RAPID PROTO TYPING**

(Mechanical Engineering)

Time: 3 hours Max. Marks: 70

## PART – A

(Compulsory Question)

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- 1 Answer the following:  $(10 \times 02 = 20 \text{ Marks})$ 
  - (a) What are the key aspects of RP?
  - (b) List out the materials used in SLS along with the applications.
  - (c) Explain the fundamental principle of solid ground curing.
  - (d) What are the factors that influence the performance of LOM process?
  - (e) Explain the working principle of 3-D printer.
  - (f) Sketch the Modeler used for multi edge products.
  - (g) Differentiate soft tooling and hard tooling.
  - (h) Explain RP software magics.
  - (i) What are the data preparation errors?
  - (j) What is meant by vacuum casting?

## PART - B

(Answer all five units,  $5 \times 10 = 50 \text{ Marks}$ )

[ UNIT - I ]

2 Discuss the evolution of RP systems indicating the history and their growth rate in the industrial sector.

OR

3 List and explain different the process parameters of SLA technique.

UNIT – II

4 List advantages and disadvantages when rapid prototyping concept is applied to solid ground curing (SGC) along with the applications.

OF

5 Describe the process of fused deposition modeling and list the factors that affect the part quality.

UNIT – III

What is concept modeling? Explain the applications of RP components from concept modeling.

OF

- With a neat sketch, explain the following concept modeling techniques:
  - (a) Thermal jet printer.
  - (b) Sander's model concept.

UNIT – IV

- 8 Explain the following methods of tooling techniques with the help of neat sketch:
  - (a) Silicon rubber tooling.
  - (b) Aluminum filled epoxy tooling.

OR

9 With a neat sketch, explain Arc spray metal tooling and 3Q Keltool.

UNIT – V

- 10 Write short notes on the following:
  - (a) File exchange errors.
  - (b) Part building errors.

OR

With a neat sketch, explain different steps involved in surface generation from points cloud.